

	Type	L #	Hits	Search T xt	DBs	Time Stamp
1	BRS	L1	430420 8	grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:18
2	BRS	L2	140666 9	die or dice or IC or "integrated circuit" or chip or chips	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:19
3	BRS	L3	111379 27	contain\$4 or lid\$3 or top\$4 or cap\$4 or cover\$4 or enclosur\$4 or cas\$6 or cell\$6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:21
4	BRS	L4	293147 5	encapsulat\$4 or resin\$3 or thermoplastic\$4 or epoxy or plastic	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:22
5	BRS	L5	119563	1 same 2	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:30

	Type	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L6	331158	438/\$.ccls. or 257/\$.ccls.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:33
7	BRS	L8	29270	5 same 3	USPAT	2003/11/25 10:35
8	BRS	L10	3880	8 and 6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:36
9	BRS	L11	6479	8 same 4	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:36
10	BRS	L12	51838	1 near8 2	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:37
11	BRS	L13	4776	12 and 6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:38

	Type	L #	Hits	Search Text	DBs	Time Stamp
12	BRS	L14	9737	12 near8 3	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:40
13	BRS	L15	1022	14 and 6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:40
14	BRS	L17	10557	1 same 2 same 3 same 4	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:43
15	BRS	L16	766	15 and 4	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:46
16	BRS	L18	1919	17 and 6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:48

	Type	L #	Hits	Search Text	DBs	Time Stamp
17	BRS	L19	11100	(1 and 2).ti.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:49
18	BRS	L20	106223 0	1.ti.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:51
19	BRS	L21	22521	(4 and 2).ti.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:52
20	BRS	L22	24849	20 and 5	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:52
21	BRS	L23	1775	21 and 5	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 10:52

	Typ	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	4304208	grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:22
2	BRS	L2	1406669	die or dice or IC or "integrated circuit" or chip or chips	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:22
3	BRS	L3	11137927	contain\$4 or lid\$3 or top\$4 or cap\$4 or cover\$4 or enclosur\$4 or cas\$6 or cell\$6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:24
4	BRS	L4	2931475	encapsulat\$4 or resin\$3 or thermoplastic\$4 or epoxy or plastic	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:24
5	BRS	L5	119563	(grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) same (die or dice or IC or "integrated circuit" or chip or chips)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:24

	Type	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L6	331158	438/\$.ccls. or 257/\$.ccls.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:25
7	BRS	L7	29270	((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) same (die or dice or IC or "integrated circuit" or chip or chips)) same (contain\$4 or lid\$3 or top\$4 or cap\$4 or cover\$4 or enclosur\$4 or cas\$6 or cell\$6)	USPAT	2003/11/25 14:26
8	BRS	L8	5343	((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) same (die or dice or IC or "integrated circuit" or chip or chips)) same (contain\$4 or lid\$3 or top\$4 or cap\$4 or cover\$4 or enclosur\$4 or cas\$6 or cell\$6)) and (438/\$.ccls. or 257/\$.ccls.)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:28
9	BRS	L9	10557	((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) same (die or dice or IC or "integrated circuit" or chip or chips)) same (contain\$4 or lid\$3 or top\$4 or cap\$4 or cover\$4 or enclosur\$4 or cas\$6 or cell\$6)) same (encapsulat\$4 or resin\$3 or thermoplastic\$4 or epoxy or plastic )	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:29

	Type	L #	Hits	Search Text	DBs	Time Stamp
10	BRS	L10	51838	(grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) near8 (die or dice or IC or "integrated circuit" or chip or chips)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:29
11	BRS	L11	4776	((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) near8 (die or dice or IC or "integrated circuit" or chip or chips)) and (438/\$.ccls. or 257/\$.ccls.)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:30
12	BRS	L12	9737	((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) near8 (die or dice or IC or "integrated circuit" or chip or chips)) near8 (contain\$4 or lid\$3 or top\$4 or cap\$4 or cover\$4 or enclosur\$4 or cas\$6 or cell\$6)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:31
13	BRS	L14	1022	((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) near8 (die or dice or IC or "integrated circuit" or chip or chips)) near8 (contain\$4 or lid\$3 or top\$4 or cap\$4 or cover\$4 or enclosur\$4 or cas\$6 or cell\$6)) and (438/\$.ccls. or 257/\$.ccls.)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:33

	Type	L #	Hits	Search Text	DBs	Time Stamp
14	BRS	L15	10557	(grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) same (die or dice or IC or "integrated circuit" or chip or chips) same (contain\$4 or lid\$3 or top\$4 or cap\$4 or cover\$4 or enclosur\$4 or cas\$6 or cell\$6) same (encapsulat\$4 or resin\$3 or thermoplastic\$4 or epoxy or plastic )	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:34
15	BRS	L18	1919	((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) same (die or dice or IC or "integrated circuit" or chip or chips) same (contain\$4 or lid\$3 or top\$4 or cap\$4 or cover\$4 or enclosur\$4 or cas\$6 or cell\$6) same (encapsulat\$4 or resin\$3 or thermoplastic\$4 or epoxy or plastic )) and (438/\$.ccls. or 257/\$.ccls.)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:37
16	BRS	L19	11100	((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) and (die or dice or IC or "integrated circuit" or chip or chips)).ti.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:37
17	BRS	L20	106223 0	1.ti.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:39



	Type	L #	Hits	Search Text	DBs	Time Stamp
18	BRS	L21	22521	((encapsulat\$4 or resin\$3 or thermoplastic\$4 or epoxy or plastic ) and (die or dice or IC or "integrated circuit" or chip or chips)).ti.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:39
19	BRS	L22	24849	1.ti. and ((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) same (die or dice or IC or "integrated circuit" or chip or chips))	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:40
20	BRS	L23	1775	((((encapsulat\$4 or resin\$3 or thermoplastic\$4 or epoxy or plastic ) and (die or dice or IC or "integrated circuit" or chip or chips)).ti.) and ((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) same (die or dice or IC or "integrated circuit" or chip or chips))	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:41
21	BRS	L16	766	((((grease or greases or "animal fat" or oil\$4 or wax\$6 or solvent\$4 or liquid\$6 or fluid\$4 or coolant\$4) near8 (die or dice or IC or "integrated circuit" or chip or chips)) near8 (contain\$4 or lid\$3 or top\$4 or cap\$4 or cover\$4 or enclosur\$4 or cas\$6 or cell\$6)) and (438/\$.ccls. or 257/\$.ccls.)) and (encapsulat\$4 or resin\$3 or thermoplastic\$4 or epoxy or plastic )	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/11/25 14:42

	Type	L #	Hits	Search Text	DBs
1	IS&R	L1	2362	(438/106).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
2	IS&R	L2	872	(438/107).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
3	IS&R	L3	873	(438/108).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
4	IS&R	L4	409	(438/112).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
5	IS&R	L5	670	(438/124).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B

	Typ	L #	Hits	Search Text	DBs
6	IS&R	L6	907	(438/127).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
7	IS&R	L7	673	(438/126).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
8	IS&R	L8	425	(257/685).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
9	IS&R	L9	1326	(257/686).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
10	IS&R	L10	646	(257/687).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B

	Type	L #	Hits	Search Text	DBs
11	IS&R	L11	691	(257/707).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
12	IS&R	L12	2084	(257/712).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
13	IS&R	L13	1083	(257/718).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
14	IS&R	L14	272	(257/716).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
15	IS&R	L15	3139	(257/787).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B

	Type	L #	Hits	Search Text	DBs
16	IS&R	L16	373	(257/789).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
17	IS&R	L17	257	(257/795).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B
18	IS&R	L18	637	(257/796).CCLS.	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B